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(71) Applicant (*for US only*): **BOREALIS TECHNOLOGY OY** [FI/FI]; P.O. Box 330, FI-06101 Porvoo (FI).

(72) Inventors; and

(75) Inventors/Applicants (*for US only*): **CARLSSON, Roger** [SE/SE]; Kullens väg 23, S-423 70 Säve (SE). **SULTAN, Bernt-Åke** [SE/SE]; Söbackevägen 16, S-444 42 Stenungsund (SE). **FAGRELL, Ola** [SE/SE]; Gullkragevägen 5, S-444 45 Stenungsund (SE).

(74) Agent: **KADOR & PARTNER**; Corneliusstrasse 15, 80469 Munich (DE).

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(54) Title: A SILICON CONTAINING COMPOUND AS PROCESSING AID FOR POLYOLEFIN COMPOSITION

(57) Abstract: The present invention relates to the use of a silicon containing compound as processing aid in the compounding of polyolefin compositions, wherein the silicon containing compound has a structure according to the formula (I):  $(R^1)_x[Si(R^2)_y(R^3)_z]_m$  wherein  $R^1$ , which may be the same or different if more than one such group is present, is a monofunctional, or, if  $m = 2$ , is a bifunctional, hydrocarbyl residue comprising from 1 to 100 carbon atoms;  $R^2$ , which may be the same or different if more than one such group is present, is a hydrocarboxy residue comprising from 1 to 100 carbon atoms;  $R^3$ , is  $-R^4SiR^pR^q$ , wherein  $p$  is 0 to 3,  $q$  is 0 to 3, with the proviso that  $p + q$  is 3, and  $R^4$  is  $-(CH_2)_rY_s(CH_2)_t-$  where  $r$  and  $t$  independently are 1 to 3,  $s$  is 0 or 1 and  $Y$  is a difunctional heteroatomic group selected from  $-O-$ ,  $-S-$ ,  $-SO-$ ,  $-SO_2-$ ,  $-NH-$ ,  $-NR^1-$  or  $-PR^1-$ , where  $R^1$  and  $R^2$  are as previously defined; and  $x$  is 0 to 3,  $y$  is 1 to 4,  $z$  is 0 or 1, with the proviso that  $x + y + z = 4$ ; and  $m = 1$  or 2, and to the use of such a compound in the production of an article, in particular a wire or cable, comprising such polyolefin compositions.



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## **A Silicon Containing Compound as Processing Aid for Polyolefin Compositions**

The present invention relates to the use of a silicon containing compound as processing aid in the compounding of polyolefin compositions and to a process for compounding a polyolefin composition comprising a silicon containing compound as processing aid.

Polyolefin compositions often comprise several polymeric components, as for example polyolefin resins with different properties, such as different molecular weights, or different content of comonomer. Furthermore, organic and/or inorganic additives such as stabilizers are usually present in a polyolefin composition. The nature and amount of these polyolefin resins and these additives is dependent on the particular use a polyolefin composition is designed for.

In order to obtain a homogeneous end-product, it is important that a very good mixing of the components of the polyolefin composition is obtained, including a very good dispersion of the additives in the polymer matrix. Furthermore, also a high throughput in the processing step, e.g. a high output of an extruder in which the composition is extruded, is desired.

When compounding the polyolefin composition e.g. by extrusion, it is known that mixing, and hence dispersion of the additives, can be improved by higher energy input into the extruder. Of course, also a higher output of the extruder requires higher energy input into the extruder. However, due to an increase of temperature of the polyolefin composition created by friction the amount of energy input and hence the output of the extruder is limited, because usually the polyolefin composition starts degrading at a

temperature of about 200 °C. It would thus be desirable to have a polyolefin composition allowing for higher energy input into an extruder and hence higher output of the extruder, at lower temperatures thus avoiding degradation of the polyolefin.

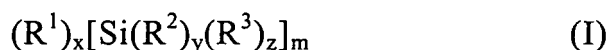
5 Furthermore, in order to avoid degradation of the polyolefin as far as possible and to maximise extruder output, it is also desirable that the composition remains in the extruder as short as possible, i.e. it is desirably to decrease the retention time in the extruder.

10 Finally, for many applications, such as semiconductive layers in medium or high voltage cables, a high surface quality, including surface smoothness, of the extruded polyolefin composition is required.

It is hence an object of the present invention to provide a processing aid for use in polyolefin compositions, thereby improving the processing properties of the polyolefin compositions, in particular resulting in lower  
15 extrusion temperature and higher throughput upon extrusion, decreased retention time in the extruder, and improved surface quality after extrusion.

It has now surprisingly been found that the above objects can be achieved by using a silicon containing compound as processing aid in the compounding for polyolefin compositions.

20 The present invention therefore provides the use of a silicon containing compound as processing aid in the compounding of a polyolefin composition, wherein the silicon containing compound has a structure according to the formula



25 wherein

$R^1$ , which may be the same or different if more than one such group is present, is a monofunctional, or, if  $m = 2$ , is a bifunctional, hydrocarbyl residue comprising from 1 to 100 carbon atoms;

$R^2$ , which may be the same or different if more than one such group is present, is a hydrocarbyloxy residue comprising from 1 to 100 carbon atoms;

$R^3$ , is  $-R^4SiR^1_pR^2_q$ , wherein

$p$  is 0 to 3, preferably 0 to 2,

$q$  is 0 to 3, preferably 1 to 3,

with the proviso that  $p + q$  is 3, and

$R^4$  is  $-(CH_2)_rY_s(CH_2)_t-$  where  $r$  and  $t$  independently are 1 to 3,  $s$  is 0 or 1 and  $Y$  is a difunctional heteroatomic group selected from  $-O-$ ,  $-S-$ ,  $-SO-$ ,  $-SO_2-$ ,  $-NH-$ ,  $-NR^1-$  or  $-PR^1-$ , where  $R^1$  and  $R^2$  are as previously defined; and

$x$  is 0 to 3,  $y$  is 1 to 4,  $z$  is 0 or 1, with the proviso that  $x + y + z = 4$ ;

and  $m = 1$  or 2.

The use according to the invention results in an improved processing behaviour of the polyolefin composition because it enables e.g. extrusion of a polyolefin composition at significantly decreased temperature and, at the same time, with very good dispersion and high output. Thus, much longer production campaigns are possible.

Still further, the composition after compounding has a very good surface quality, e.g. surface smoothness and low gels content. In particular, the high surface quality is obtained also immediately upon compounding of new material of the composition, after the compounding unit has been stopped for a certain time, e.g. for tool change.

In particular, the processing aid of the invention decreases the retention of the polyolefin composition in the compounding unit. Compounding includes all forms of melt-mixing polyolefin compositions, including the production of pellets or final articles.

5     Compounding of the polyolefin composition preferably is done by extrusion.

Preferably, the silicon containing compound has a high compatibility with the polymer composition which means that even after treatment of the composition at elevated temperature for several hours the major part of the  
10     silicon containing compound does not volatise from the composition. The compatibility of the silicon containing compound can be adjusted by appropriate selection of, especially, group  $R^1$ , which should be chosen sufficiently large and non-polar.

Further on, preferably, in formula (I) for the silicon containing compound:

15              $R^1$ , which may be the same or different if more than one such group is present, is an alkyl, arylalkyl, alkylaryl or aryl group containing 1 to 40 carbon atoms, with the proviso that if more than one  $R^1$  group is present the total number of carbon atoms of the  $R^1$  groups is at most 60,

20     and more preferably:

$R^1$ , which may be the same or different if more than one such group is present, is a linear or branched  $C_6$ - to  $C_{22}$ -alkyl, still more preferably is a  $C_8$ - to  $C_{20}$ -alkyl group.

Furthermore, preferably in formula (I) for the silicon containing compound:

25              $R^2$ , which may be the same or different if more than one such group is present, is an alkoxy, aryloxy, alkylaryloxy, or

arylalkyloxy group containing 1 to 15 carbon atoms, with the proviso that if more than one  $R^2$  group is present the total number of carbon atoms in the alkyl moieties of the  $R^2$  groups is at most 40,

5 more preferably:

$R^2$ , which may be the same or different if more than one such group is present, is a linear or branched  $C_1$ - to  $C_{10}$ -alkoxy, still more preferably is a  $C_1$ - to  $C_8$ -alkoxy, still more preferably is a  $C_1$ - to  $C_4$ -alkoxy, and most preferably is a  
10 methoxy, ethoxy, propoxy, or 1-butoxy group.

The alkyl moieties of  $R^1$  and  $R^2$  may be linear or branched.

$R^1$  and  $R^2$  may comprise heteroatom substituents, however, preferably  $R^1$  and  $R^2$  are free of any heteroatom substituents.

Preferably, in formula (I)  $x = 1$ .

15 Furthermore, preferably in formula (I)  $y = 3$ .

Still further, preferably in formula (I)  $z = 0$ .

Finally, preferably in formula (I)  $m = 1$ .

Preferred silicon containing compounds are also all those compounds which are combinations of any of the above-mentioned preferred  
20 embodiments for any of the parameters of formula (I).

In a particularly preferred embodiment, the silicon containing compound comprises, more preferably consists of, hexadecyl trimethoxy silane.

The amount of the silicon containing compound in the polyolefin composition preferably is from 0.001 to 5 wt% of the total composition,

more preferably from 0.01 to 2.5 wt% of the total composition and most preferably from 0.5 to 1.5 wt% of the total composition.

It is known to cross-link polyolefins by means of additives as this improves the properties of the polyolefin such as mechanical strength and chemical heat resistance. Cross-linking may be performed by condensation of silanol groups contained in the polyolefin which can be obtained by hydrolysis of silane groups. A silane compound can be introduced as a cross-linkable group e.g. by grafting the silane compound onto a polyolefin, or by copolymerisation of olefin monomers and silane group containing monomers. Such techniques are known e.g. from US 4,413,066, US 4,297,310, US 4,351,876, US 4,397,981, US 4,446,283 and US 4,456,704.

For cross-linking of such polyolefins, a silanol condensation catalyst must be used. Conventional catalysts are for example tin-organic compounds such as dibutyl tin dilaurate (DBTDL). It is further known that the cross-linking process advantageously is carried out in the presence of acidic silanol condensation catalysts. In contrast to the conventional tin-organic catalysts the acidic catalysts allow cross-linking to quickly take place already at room temperature. Such acidic silanol condensation catalysts are disclosed for example in WO 95/17463. The contents of this document is enclosed herein by reference.

In a preferred embodiment of the invention, the polyolefin composition for which the above described silicon containing compound is used as a processing aid comprises a crosslinkable polyolefin with hydrolysable silane groups, and further comprises a silanol condensation catalyst.

It is found that such compositions in the extruder behave very similar to an thermoplastic material upon extrusion, i.e. there is virtually no drop in melt flow rate upon extrusion, and the retention time in the extruder is

significantly decreased, when the silicon containing compound as described above is used as a processing aid. This again proves the excellent impact on the processing properties of the composition caused by the silicon containing compound.

5 The use of the silicon containing compound according to the invention has therefore both an internal effect, e.g. a good mixing and dispersion in the polyolefin composition, and an external effect, i.e. it functions as processing aid between the extruder and the polymer melt. The external effect is the main issue.

10 In the preferred embodiment mentioned above, the silanol condensation catalysts of the polyolefin composition preferably is a Brönsted acid, i.e. is a substance which acts as a proton donor.

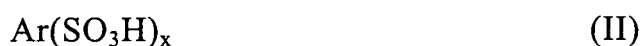
More particularly, the silicon containing compound, preferably, is compatible with the composition insofar as it, when having been present in the composition in an initial amount corresponding to 0.060 mole hydrolysable groups per 1000 g composition, after a storage at 60 °C for 74 h in air is still present in the composition at least in an amount corresponding to 0.035 mole hydrolysable groups per 1000 g composition. The Brönsted acids may comprise inorganic acids such as sulphuric acid and hydrochloric acid, and organic acids such as citric acid, stearic acid, acetic acid, sulphonic acid and alkanoic acids as dodecanoic acid, or a precursor of any of the compounds mentioned.

20 Preferably, the Brönsted acid is a sulphonic acid, more preferably an organic sulphonic acid.

25 Still more preferably, the Brönsted acid is an organic sulphonic acid comprising 10 C-atoms or more, more preferably 12 C-atoms or more, and

most preferably 14 C-atoms or more, the sulphonic acid further comprising at least one aromatic group which may e.g. be a benzene, naphthalene, phenantrene or anthracene group. In the organic sulphonic acid, one, two or more sulphonic acid groups may be present, and the sulphonic acid group(s) may either be attached to a non-aromatic, or preferably to an aromatic group, of the organic sulphonic acid.

Further preferred, the aromatic organic sulphonic acid comprises the structural element:



with Ar being an aryl group which may be substituted or non-substituted, and x being at least 1.

The organic aromatic sulphonic acid silanol condensation catalyst may comprise the structural unit according to formula (II) one or several times, e.g. two or three times. For example, two structural units according to formula (II) may be linked to each other via a bridging group such as an alkylene group.

Preferably, Ar is a aryl group which is substituted with at least one C<sub>4</sub>- to C<sub>30</sub>-hydrocarbyl group, more preferably C<sub>4</sub>- to C<sub>30</sub>-alkyl group.

Aryl group Ar preferably is a phenyl group, a naphthalene group or an aromatic group comprising three fused rings such as phenantrene and anthracene.

Preferably, in formula (II) x is 1, 2 or 3, and more preferably x is 1 or 2.

Furthermore, preferably the compound used as organic aromatic sulphonic acid silanol condensation catalyst has from 10 to 200 C-atoms, more preferably from 14 to 100 C-atoms.

In one preferred embodiment, Ar is a hydrocarbyl substituted aryl group and the total compound containing 14 to 28 carbon atoms, and still further preferred, the Ar group is a hydrocarbyl substituted benzene or naphthalene ring, the hydrocarbyl radical or radicals containing 8 to 20 carbon atoms in the benzene case and 4 to 18 atoms in the naphthalene case.

It is further preferred that the hydrocarbyl radical is an alkyl substituent having 10 to 18 carbon atoms and still more preferred that the alkyl substituent contains 12 carbon atoms and is selected from dodecyl and tetrapropyl. Due to commercial availability it is most preferred that the aryl group is a benzene substituted group with an alkyl substituent containing 12 carbon atoms.

The currently most preferred compounds are dodecyl benzene sulphonic acid and tetrapropyl benzene sulphonic acid.

The silanol condensation catalyst may also be precursor of the sulphonic acid compound, including all its preferred embodiments mentioned, i.e. a compound that is converted by hydrolysis to such a compound. Such a precursor is for example the acid anhydride of a sulphonic acid compound, or a sulphonic acid that has been provided with a hydrolysable protective group, as e.g. an acetyl group, which can be removed by hydrolysis.

In a second preferred embodiment, the sulphonic acid catalyst is selected from those as described in EP 1 309 631 and EP 1 309 632, namely

a) a compound selected from the group of

(i) an alkylated naphthalene monosulfonic acid substituted with 1 to 4 alkyl groups wherein each alkyl group is a linear or branched alkyl with 5 to 40 carbons with each alkyl group being the same or different and

wherein the total number of carbons in the alkyl groups is in the range of 20 to 80 carbons;

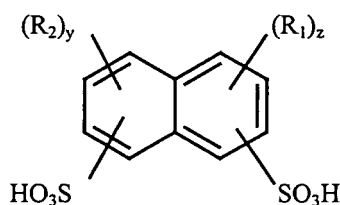
(ii) an arylalkyl sulfonic acid wherein the aryl is phenyl or naphthyl and is substituted with 1 to 4 alkyl groups wherein each alkyl group is a linear or branched alkyl with 5 to 40 carbons with each alkyl group being the same or different and wherein the total number of carbons in the alkyl groups is in the range of 12 to 80;

(iii) a derivative of (i) or (ii) selected from the group consisting of an anhydride, an ester, an acetylate, an epoxy blocked ester and an amine salt thereof which is hydrolysable to the corresponding alkyl naphthalene monosulfonic acid or the arylalkyl sulfonic acid;

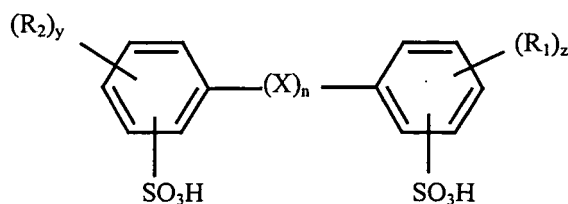
(iv) a metal salt of (i) or (ii) wherein the metal ion is selected from the group consisting of copper, aluminium, tin and zinc; and

b) a compound selected from the group of

(i) an alkylated aryl disulfonic acid selected from the group consisting of the structure (III):



and the structure (IV):



wherein each of  $R_1$  and  $R_2$  is the same or different and is a linear or branched alkyl group with 6 to 16 carbons,  $y$  is 0 to 3,  $z$  is 0 to 3 with the proviso that  $y + z$  is 1 to 4,  $n$  is 0 to 3,  $X$  is a divalent moiety selected from the group consisting of  $-C(R_3)(R_4)-$ , wherein each of  $R_3$  and  $R_4$  is H or  
5 independently a linear or branched alkyl group of 1 to 4 carbons and  $n$  is 1;  $-C(=O)-$ , wherein  $n$  is 1;  $-S-$ , wherein  $n$  is 1 to 3 and  $-S(O)_2-$ , wherein  $n$  is 1; and

(ii) a derivative of (i) selected from the group consisting of the anhydrides, esters, epoxy blocked sulfonic acid esters, acetylates, and  
10 amine salts thereof which is a hydrolysable to the alkylated aryl disulfonic acid,

together with all preferred embodiments of those sulphonic acids as described in the mentioned European Patents.

Preferably, in the polyolefin composition the silanol condensation catalyst  
15 is present in an amount of 0.0001 to 6 wt%, more preferably of 0.001 to 2 wt%, and most preferably 0.02 to 0.5 wt%.

Preferably, the cross-linkable polyolefin comprises, still more preferably consists of, a polyethylene containing hydrolysable silane groups.

The hydrolysable silane groups may be introduced into the polyolefin by  
20 copolymerisation of e.g. ethylene monomers with silane group containing comonomers or by grafting, i.e. by chemical modification of the polymer by addition of silane groups mostly in a radical reaction. Both techniques are well known in the art.

Preferably, the silane group containing polyolefin has been obtained by  
25 copolymerisation. In the case of polyolefins, preferably polyethylene, the

copolymerisation is preferably carried out with an unsaturated silane compound represented by the formula



wherein

5  $R^1$  is an ethylenically unsaturated hydrocarbyl, hydrocarbyloxy or (meth)acryloxy hydrocarbyl group,

$R^2$  is an aliphatic saturated hydrocarbyl group,

Y which may be the same or different, is a hydrolysable organic group and

q is 0, 1 or 2.

10 Special examples of the unsaturated silane compound are those wherein  $R^1$  is vinyl, allyl, isopropenyl, butenyl, cyclohexanyl or gamma-(meth)acryloxy propyl; Y is methoxy, ethoxy, formyloxy, acetoxy, propionyloxy or an alkyl- or arylamino group; and  $R^2$ , if present, is a methyl, ethyl, propyl, decyl or phenyl group.

15 A preferred unsaturated silane compound is represented by the formula



wherein A is a hydrocarbyl group having 1–8 carbon atoms, preferably 1–4 carbon atoms.

The most preferred compounds are vinyl trimethoxysilane, vinyl  
20 bismethoxyethoxysilane, vinyl triethoxysilane, gamma-(meth)acryloxypropyltrimethoxysilane, gamma(meth)acryloxypropyltriethoxysilane, and vinyl triacetoxysilane.

The copolymerisation of the olefin, e.g. ethylene, and the unsaturated silane compound may be carried out under any suitable conditions resulting in the copolymerisation of the two monomers.

Moreover, the copolymerisation may be implemented in the presence of one or more other comonomers which can be copolymerised with the two monomers. Such comonomers include (a) vinyl carboxylate esters, such as vinyl acetate and vinyl pivalate, (b) alpha-olefins, such as propene, 1-butene, 1-hexene, 1-octene and 4-methyl-1-pentene, (c) (meth)acrylates, such as methyl(meth)acrylate, ethyl(meth)acrylate and butyl(meth)acrylate, (d) olefinically unsaturated carboxylic acids, such as (meth)acrylic acid, maleic acid and fumaric acid, (e) (meth)acrylic acid derivatives, such as (meth)acrylonitrile and (meth)acrylic amide, (f) vinyl ethers, such as vinyl methyl ether and vinyl phenyl ether, and (g) aromatic vinyl compounds, such as styrene and alpha-ethyl styrene.

Amongst these comonomers, vinyl esters of monocarboxylic acids having 1–4 carbon atoms, such as vinyl acetate, and (meth)acrylate of alcohols having 1–4 carbon atoms, such as methyl(meth)-acrylate, are preferred.

Especially preferred comonomers are butyl acrylate, ethyl acrylate and methyl acrylate.

Two or more such olefinically unsaturated compounds may be used in combination. The term "(meth)acrylic acid" is intended to embrace both acrylic acid and methacrylic acid. The comonomer content of the copolymer may amount to 70 wt% of the copolymer, preferably about 0.5 to 35 wt%, most preferably about 1 to 30 wt%.

If using a graft polymer, this may have been produced e.g. by any of the two methods described in US 3,646,155 and US 4,117,195, respectively.

The silane-group containing polyolefin preferably contains 0.001 to 15 wt% of the silane compound, more preferably 0.01 to 5 wt%, most preferably 0.1 to 2 wt%.

Such a polyolefin composition when extruded together with the above described silicon containing compound as a processing aid exhibits almost thermoplastic behaviour. This means, inter alia, that the melt flow rate of the composition does not significantly drop upon extrusion even at comparatively high temperatures.

Therefore, preferably the polyolefin composition has a MFR<sub>21</sub> (190 °C, 21.6 kg) of 50 g/10 min or more, more preferably 60 g/10 min or more, and most preferably 70 g/10 min or more when extruded at any temperature in the range of from 20 to 240 °C.

Furthermore, it is preferred that the MFR<sub>21</sub> (190 °C, 21.6 kg) of the composition when extruded at any temperature in the range of from 140 to 240 °C is 90 % or more, more preferably 95 % or more, of the MFR<sub>21</sub> (190 °C, 21.6 kg) of the same composition extruded without silanol condensation catalyst.

The polymer composition may further contain various additives, such as miscible thermoplastics, antioxidants, further stabilizers, lubricants, fillers, colouring agents and foaming agents.

As antioxidant, preferably a compound, or a mixture of such compounds, is used which is neutral or acidic, must comprise a sterically hindered phenol group or aliphatic sulphur groups. Such compounds are disclosed in EP 1 254 923 to be particularly suitable antioxidants for stabilisation of polyolefins containing hydrolysable silane groups which are crosslinked with a silanol condensation catalyst, in particular an acidic silanol

condensation catalyst. Other preferred antioxidants are disclosed in WO2005003199A1.

Preferably, the antioxidant is present in the composition in an amount of from 0.01 to 3 wt%, more preferably 0.05 to 2 wt%, and most preferably  
5 0.08 to 1.5 wt%.

The silanol condensation catalyst usually is added to the silane-group containing polyolefin by compounding the polymer with a so-called master batch, in which the catalyst, and optionally further additives are contained in a polymer, e.g. polyolefin, matrix in concentrated form.

10 The silanol condensation catalyst and the silicon containing compound are preferably added to the silane group containing polyolefin by compounding a master batch, which contains the silanol condensation catalyst and the silicon containing compound in a polymer matrix in concentrated form, with the silane group containing polyolefin.

15 The matrix polymer is preferably a polyolefin, more preferably a polyethylene, which may be a homo- or copolymer of ethylene, e.g. low density polyethylene, or polyethylene-methyl-ethyl-butyl-acrylate copolymer containing 1 to 50 wt% of the acrylate, and mixtures thereof.

As stated, in the master batch the compounds to be added to the silane  
20 group containing polyolefin are contained in concentrated form, i.e. in a much higher amount than in the final composition.

The master batch preferably comprises the silanol condensation catalyst in an amount of from 0.3 to 6 wt%, more preferably from 0.7 to 3.5 wt%.

The silicon containing compound preferably is present in the master batch  
25 in an amount of from 1 to 20 wt%, more preferably from 2 to 10 wt%.

The master batch preferably is processed with the silane group containing polymer in an amount of from 1 to 10 wt%, more preferably from 2 to 8 wt%.

Compounding may be performed by any known compounding process,  
5 including extruding the final product with a screw extruder or a kneader.

The present invention furthermore relates to a process for compounding a polyolefin composition wherein the composition is compounded in the presence of a silicon containing compound according to any of the above described embodiments.

10 Preferably, the present invention relates to a process for producing an article comprising extrusion of a polyolefin composition in which the silicon containing compound is used according to any of the above described embodiments at a temperature in the range of 140 to 280 °C, more preferably in the range of 160 to 240 °C, and most preferably in the  
15 range of 180 to 200 °C.

In a particularly preferred embodiment, the invention relates to the use of a silicon containing compound in any of the above described embodiments as a processing aid which reduces the retention time of a composition comprising a polyolefin comprising hydrolysable silane groups and a  
20 Brönsted acid as a silanol condensation catalyst in the extruder and/or reduces the extrusion temperature in the extrusion of said composition.

Finally, the invention also relates to the use of a silicon containing compound in any of the above described embodiments as a surface  
25 smoothening agent in a composition comprising a polyolefin comprising hydrolysable silane groups and a Brönsted acid as a silanol condensation catalyst.

The following examples serve to further illustrate the present invention.

## Examples

### 1. Measurement Methods

#### a) Melt Flow Rate

5 The melt flow rate (MFR) is determined according to ISO 1133 and is indicated in g/10 min. The MFR is an indication of the flowability, and hence the processability, of the polymer. The higher the melt flow rate, the lower the viscosity of the polymer. The MFR is determined at 190 °C and may be determined at different loadings such as 2.16 kg (MFR<sub>2</sub>) or 21.6 kg  
10 (MFR<sub>21</sub>).

### 2. Compositions Produced

#### a) Master batches

Master batches were produced comprising:

- 15 - a matrix resin: an ethylene butylacrylate copolymer with 17 wt% butylacrylate, a density of 924 kg/m<sup>3</sup> and a MFR<sub>2</sub> of 7.0 g/10 min (OE6417 available from Borealis);
- a silanol condensation catalyst: linear dodecylbenzene sulphonic acid (DDBSA) has been used; or dibutyl tin dilaurate (DBTL) as a conventional silanol condensation catalyst;
- 20 - a silicon containing compound: hexadecyl trimethoxy silane (HDTMS),

- an antioxidant: 4-methyl-phenol reaction products with dicyclopentadiene and isobutylene (Ralox LC, CAS-no. 68610-51-5).

The components were used in the master batches in the amounts as indicated in Table 1 (wt%). Compounding of the master batches was performed using a Brabender kneader (small chamber, 47 cm<sup>3</sup>), and 3 mm thick plates were compression moulded at 180 °C.

Table 1:

	Example 1	Comparative Example 1	Comparative Example 2	Comparative Example 3
Matrix	88.5	92.5	90	87
Sulphonic acid	1.5	1.5	-	-
DBTL	-	-	-	3
HDTMS	4	-	4	4
Antioxidant	6	6	6	6

#### b) Compositions

- The master batches of Table 1 were processed in an amount of 5 wt% with 95 wt% of a silane group containing polyethylene having a density of 923 kg/m<sup>3</sup>, a MFR<sub>2</sub> of 0.9 g/10 min and a silane copolymer content of 1.3 wt% in a Brabender kneader followed by tape extrusion.

#### c) Retention Time

- Retention time in the extruder was measured by adding a black coloured pellet into the inlet of the extruder during extruding the colourless compositions of Example 1 and Comparative Example 1. Then, the time period (T<sub>1</sub>) between introduction of the black pellet at the extruder inlet

and the appearance of black coloured polymer at the outlet of the extruder was measured, and the time period ( $T_2$ ) between introduction of the black pellet at the extruder inlet and the total disappearance of black coloured polymer at the outlet of the extruder. The total retention time was then  
5 determined by the difference of  $T_2$  and  $T_1$ . The results of the experiments are given in Table 2:

Table 2:

	Example 1	Comparative Example 1
$T_1$	2 min 35 sec	2 min 55 sec
$T_2$	3 min 55 sec	5 min 30 sec
Retention time ( $T_2 - T_1$ )	1 min 20 sec	3 min 35 sec

Example 1 according to the invention has a significantly shorter retention  
10 time in relation to Comparative Example 1.

d) Melt Flow Rate as Function of Temperature

The  $MFR_{21}$  (190 °C, 21.6 kg) of the compositions of Example 1 and Comparative Examples 2 and 3 was measured before extrusion. Then, on a 60 mm Troester cable extruder with a PE screw having a compression ratio  
15 of 1 : 3.6, the material was extruded onto floor at different temperature settings. For each temperature setting the melt temperature was measured and samples collected. Directly after extrusion the  $MFR_{21}$  was measured. The results are given in Table 3.

Table 3:

Melt temperature/°C	Before extrusion	After extrusion					
		150	170	190	210	225	240
Example 1	74	74	74	73	72	69	69
Comparative Example 2	74	74	74	74	72	69	69
Comparative Example 3	74	50	48	45	45	45	34

Example 1 is according to the invention. The comparison with Comparative Example 2 shows that the composition according to the invention behaves like a thermoplastic resin. Thus, no crosslinking occurs in the extruder, which can be seen in the constant MFR<sub>21</sub> level. Comparative Example 3 shows a composition which uses DBTL as a silanol condensation catalyst containing HDTMS demonstrating inferior behaviour as can be seen in the lowered MFR<sub>21</sub>. Therefore, a combination of the right crosslinking catalyst and the processing aid according to the invention gives the best performance.

#### e) Tape Surface

The compositions of Example 1, and Comparative Examples 1, 2 and 3 were extruded in a Brabender tape extruder with a tape forming die having a melt temperature of 210 °C for 10 min. A 4 : 1 compression was used, and the heat was adjusted to 160 °C, 180 °C and 210 °C for the different zones of the extruder. Water cooling was used on the feeding zone. The rotation speed was 30 rpm. Extrusion initially took place for 30 min.

To simulate time for tool changes, the extruder was stopped for the time indicated in Table 4. The extruder was then started again and after 30 min a tape sample for inspection was collected.

The tapes produced were visually inspected and the surface quality was rated according to the amount of gels counted, haziness and irregularities of the tape. In the rating, the numbers mean: 5 is good (the tape has no gels, perfect finish, no irregular shaped edges, thin and transparent look), 3 is acceptable to be used for commercial production (there are a number of small gels, the tape is somewhat hazy but still the edges of the tape is perfect), and below 3 is not acceptable for commercial use (there are significant amount of small gels and or some larger ones > 1 mm).

The results are given in Table 4.

Table 4:

Extruder stop time (min)	0	5	10	15	30	60
Example 1	5	5	5	5	5	2
Comparative Example 1	1	1	1	1	1	1
Comparative Example 2	5	5	5	5	5	2
Comparative Example 3	5	5	5	3	1	1

Example 1 is according to the invention and has excellent scorch tape rating after extrusion stops up to 30 minutes. Comparative Example 1 shows a non extricable composition since it is full of gels. Comparative Example 2 shows a thermoplastic behaviour which is similar to Example 1. Comparative Example 3 shows an inferior behaviour compared to the composition according to the invention. Therefore, a combination of the right crosslinking catalyst and the processing aid according to the invention gives the best performance.

## Claims

1. Use of a silicon containing compound as processing aid in the compounding of a polyolefin composition, wherein the silicon containing compound has a structure according to the formula



wherein

$R^1$ , which may be the same or different if more than one such group is present, is a monofunctional, or, if  $m = 2$ , is a bifunctional, hydrocarbyl residue comprising from 1 to 100 carbon atoms;

$R^2$ , which may be the same or different if more than one such group is present, is a hydrocarbyloxy residue comprising from 1 to 100 carbon atoms;

$R^3$ , is  $-R^4SiR^1_pR^2_q$ , wherein

$p$  is 0 to 3,

$q$  is 0 to 3,

with the proviso that  $p + q$  is 3, and

$R^4$  is  $-(CH_2)_rY_s(CH_2)_t-$  where  $r$  and  $t$  independently are 1 to 3,  $s$  is 0 or 1 and  $Y$  is a difunctional heteroatomic group selected from  $-O-$ ,  $-S-$ ,  $-SO-$ ,  $-SO_2-$ ,  $-NH-$ ,  $-NR^1-$  or  $-PR^1-$ , where  $R^1$  and  $R^2$  are as previously defined; and

$x$  is 0 to 3,  $y$  is 1 to 4,  $z$  is 0 or 1, with the proviso that  $x + y + z = 4$ ;

and  $m = 1$  or  $2$ .

2. Use according to claim 1, wherein in the formula for the silicon containing compound:

$R^1$ , which may be the same or different if more than one such group is present, is an alkyl, arylalkyl, alkylaryl or aryl group containing 1 to 30 carbon atoms, with the proviso that if more than one  $R^1$  group is present the total number of carbon atoms of the  $R^1$  groups is at most 60; and

$R^2$ , which may be the same or different if more than one such group is present, is an alkoxy, aryloxy, alkylaryloxy, or arylalkyloxy group containing 1 to 15 carbon atoms, with the proviso that if more than one  $R^2$  group is present the total number of carbon atoms in the alkyl moieties of the  $R^2$  groups is at most 40.

3. Use according to claim 1 or 2 wherein in the formula for the silicon containing compound:

$R^1$  is a linear or branched  $C_6$ - to  $C_{22}$ -alkyl group.

4. Use according to any of the preceding claims wherein in the formula for the silicon containing compound:

$R^2$  is a linear or branched  $C_1$ - to  $C_{10}$ -alkoxy group.

5. Use according to any of the preceding claims wherein in the formula for the silicon containing compound:

$x = 1$ ,  $y = 3$ ,  $z = 0$ , and  $m = 1$ .

6. Use according to any of the preceding claims wherein the silicon containing compound comprises hexadecyl trimethoxy silane.

7. Use according to any of the preceding claims wherein the amount of the silicon containing compound is 0.001 to 5 wt% of the total composition.
8. Use according to any of the preceding claims wherein the polyolefin composition comprises a crosslinkable polyolefin with hydrolysable silane groups.
9. Use according to claim 8 wherein the crosslinkable polyolefin with hydrolysable silane groups comprises a polyethylene with hydrolysable silane groups.
10. Use according to claims 8 or 9 wherein in the crosslinkable polyolefin with hydrolysable silane groups the silane groups are present in an amount of 0.001 to 15 wt%.
11. Use according to any one of claims 8 to 10 wherein the composition further comprises a silanol condensation catalyst.
12. Use according to claim 11 wherein the silanol condensation catalyst comprises an organic sulphonic acid.
13. Use according to claim 12 wherein the silanol condensation catalyst comprises an organic sulphonic acid comprising 10 C-atoms or more, the sulphonic acid further comprising at least one aromatic group.
14. Use according to any one of claims 11 to 13 wherein the silanol condensation catalyst comprises an organic sulphonic acid comprising the structural element:



with Ar being an aryl group which may be substituted or non-substituted, and x being at least 1.

15. Use according claim 14 wherein in formula (II) Ar is substituted with at least one C<sub>4</sub>- to C<sub>30</sub>-hydrocarbyl group and the total silanol condensation catalyst comprises from 10 to 200 C-atoms.
16. Use according to any one of claims 11 to 15 wherein the composition has a MFR<sub>21</sub> (190 °C, 21.6 kg) of 50 g/10 min or more when extruded at any temperature in the range of from 20 to 240 °C.
17. Use according to any one of claims 11 to 16 wherein the MFR<sub>21</sub> (190 °C, 21.6 kg) of the composition when extruded at any temperature in the range of from 140 to 240 °C is 90 % or more of the MFR<sub>21</sub> (190 °C, 21.6 kg) of the same composition without silanol condensation catalyst.
18. Process for compounding a polyolefin composition wherein the composition is compounded in the presence of a silicon containing compound according to the formula:



wherein

R<sup>1</sup>, which may be the same or different if more than one such group is present, is a monofunctional, or, if m = 2, is a bifunctional, hydrocarbyl residue comprising from 1 to 100 carbon atoms;

R<sup>2</sup>, which may be the same or different if more than one such group is present, is a hydrocarbyloxy residue comprising from 1 to 100 carbon atoms;

R<sup>3</sup>, is -R<sup>4</sup>SiR<sup>1</sup><sub>p</sub>R<sup>2</sup><sub>q</sub>, wherein

p is 0 to 3,

q is 0 to 3,

with the proviso that  $p + q$  is 3, and

$R^4$  is  $-(CH_2)_r Y_s (CH_2)_t -$  where  $r$  and  $t$  independently are 1 to 3,  
s is 0 or 1 and  $Y$  is a difunctional heteroatomic group selected  
5 from  $-O-$ ,  $-S-$ ,  $-SO-$ ,  $-SO_2-$ ,  $-NH-$ ,  $-NR^1-$  or  $-PR^1-$ , where  $R^1$   
and  $R^2$  are as previously defined; and

$x$  is 0 to 3,  $y$  is 1 to 4,  $z$  is 0 or 1, with the proviso that  
 $x + y + z = 4$ ;

and  $m = 1$  or 2.

# INTERNATIONAL SEARCH REPORT

International application No  
PCT/EP2007/004590

## A. CLASSIFICATION OF SUBJECT MATTER

INV. C08K5/00 C08K5/5415 C08K5/5419 C08L23/00 C08L23/04  
C08L23/08 C08L23/14 C08L23/16

According to International Patent Classification (IPC) or to both national classification and IPC

## B. FIELDS SEARCHED

Minimum documentation searched (classification system followed by classification symbols)

C08K C08L

Documentation searched other than minimum documentation to the extent that such documents are included in the fields searched

Electronic data base consulted during the international search (name of data base and, where practical, search terms used)

EPO-Internal, WPI Data

## C. DOCUMENTS CONSIDERED TO BE RELEVANT

Category*	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.
X	US 3 100 753 A (SPENCER FRAMROZE J) 13 August 1963 (1963-08-13)	1-18
X	column 1, line 41 - column 2, line 52; claims 1-8	1-5,7,18
Y	claims 1-8	6,8-17
X	US 4 117 195 A (SWARBRICK PETER ET AL) 26 September 1978 (1978-09-26)	18
X	claims 1,10,19; examples 1-19	18
Y	claims 1,10,19; examples 1-19	6,8-17
X	US 4 297 310 A (AKUTSU SUSUMU ET AL) 27 October 1981 (1981-10-27)	18
X	column 6, lines 51-54	18
Y	the whole document	6,8-17
	----- -/--	



Further documents are listed in the continuation of Box C.



See patent family annex.

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\*A\* document defining the general state of the art which is not considered to be of particular relevance

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\*X\* document of particular relevance; the claimed invention cannot be considered novel or cannot be considered to involve an inventive step when the document is taken alone

\*Y\* document of particular relevance; the claimed invention cannot be considered to involve an inventive step when the document is combined with one or more other such documents, such combination being obvious to a person skilled in the art.

\*Z\* document member of the same patent family

Date of the actual completion of the international search

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Name and mailing address of the ISA/

European Patent Office, P.B. 5818 Patentlaan 2  
NL - 2280 HV Rijswijk  
Tel. (+31-70) 340-2040, Tx. 31 651 epo nl,  
Fax: (+31-70) 340-3016

Authorized officer

Feldmann, Gabriele

## INTERNATIONAL SEARCH REPORT

International application No

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C(Continuation). DOCUMENTS CONSIDERED TO BE RELEVANT

Category*	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.
X	GB 2 067 132 A (MITSUBISHI PETROCHEMICAL CO) 22 July 1981 (1981-07-22)	18
X	page 4, lines 10-13	18
Y	the whole document	6,8-17
X	----- US 6 342 552 B1 (HERGENROTHER WILLIAM L [US] ET AL) 29 January 2002 (2002-01-29)	1,2,4,5, 7,18
X	column 5, lines 1-34; claims 1,14	1,2,4,5, 7,18
X	column 7, line 61	1,2,4,5, 7,18
X	column 9, line 62 - column 11, line 25	1,2,4,5, 7,18
A	----- US 4 535 113 A (FOSTER GEORGE N [US] ET AL) 13 August 1985 (1985-08-13)	1-18
A	claims 1-22	1-18
	-----	

# INTERNATIONAL SEARCH REPORT

Information on patent family members

International application No

PCT/EP2007/004590

Patent document cited in search report		Publication date	Patent family member(s)	Publication date
US 3100753	A	13-08-1963	NONE	
US 4117195	A	26-09-1978	AT 345554 B	25-09-1978
			AT 923275 A	15-01-1978
			AU 503860 B2	27-09-1979
			AU 8727975 A	09-06-1977
			BE 836338 A1	08-06-1976
			CA 1066010 A1	13-11-1979
			CH 634253 A5	31-01-1983
			CH 627402 A5	15-01-1982
			DE 2554525 A1	16-06-1976
			ES 443269 A1	16-04-1977
			FR 2293776 A1	02-07-1976
			GB 1526398 A	27-09-1978
			IT 1056172 B	30-01-1982
			JP 51082361 A	19-07-1976
			JP 58025583 B	28-05-1983
			MY 15680 A	31-12-1980
			NL 7514222 A	09-06-1976
			NO 754113 A	09-06-1976
			SE 411765 B	04-02-1980
			SE 7513728 A	08-06-1976
			ZA 7507532 A	24-11-1976
US 4297310	A	27-10-1981	DE 2944664 A1	22-05-1980
			FR 2441904 A1	13-06-1980
			GB 2039513 A	13-08-1980
			IT 1164017 B	08-04-1987
			JP 1493114 C	20-04-1989
			JP 55066809 A	20-05-1980
			JP 61014615 B	19-04-1986
			NL 7908254 A	16-05-1980
GB 2067132	A	22-07-1981	DE 3048640 A1	10-09-1981
			JP 1543850 C	15-02-1990
			JP 56093542 A	29-07-1981
			JP 63039427 B	04-08-1988
			US 4351876 A	28-09-1982
US 6342552	B1	29-01-2002	US 2003022972 A1	30-01-2003
US 4535113	A	13-08-1985	AU 570777 B2	24-03-1988
			AU 3975485 A	19-09-1985
			CA 1269781 A1	29-05-1990
			DE 3582948 D1	04-07-1991
			EP 0158140 A2	16-10-1985
			FI 850975 A	14-09-1985
			IN 164371 A1	04-03-1989
			JP 1049420 B	24-10-1989
			JP 60238340 A	27-11-1985